



SPECIFICATION FOR TFT LCD MODULE

CUSTOMER : _____

CUSTOMER MODULE : _____

HL MODEL : HG039WV004G01

Preliminary Specification

Final Specification

Customer Confirmation column:

Approved by : _____ Dept. : _____ Data : _____

Please return one of the copies of the specification with your signature to us within two weeks after you receive this document. If it is not returned, we will assume that you agree to the entire contents of this specification document.

Designed by	Checked by	Approved by



Revision History

Version NO.	DATE	Description	Remak
V1.0	2023.08.24	FIRST ISSUE	



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1. GENERAL INFORMATION

1.1 features

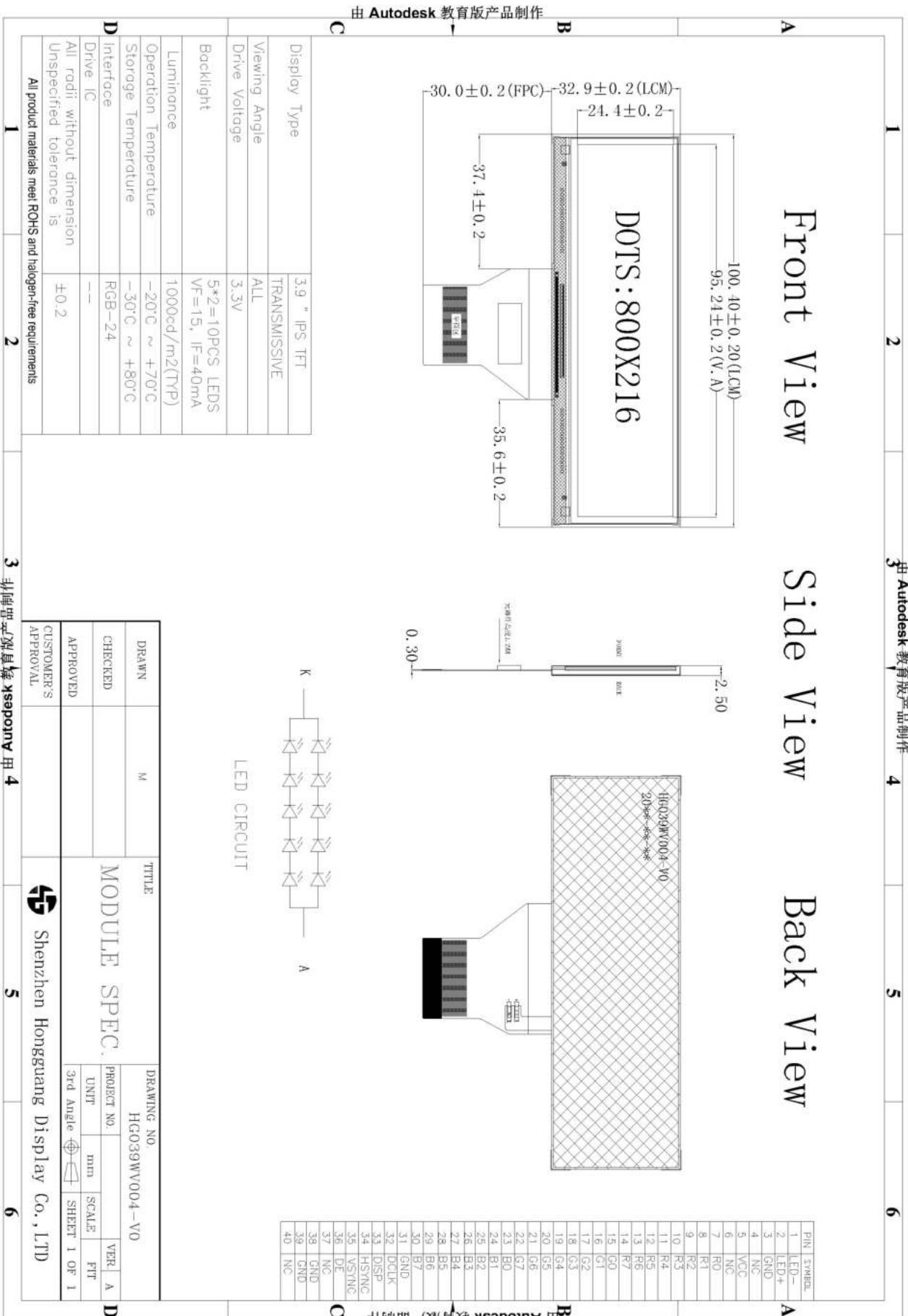
- 1) Structure: TFT PANNEL+IC+FPC+BL+GLASS
- 2) IPS Type LCD 800 dot-segment and 216 dot-common outputs
- 3) 252K Color can be selected by software
- 4) White LED back light
- 5) RGB-24 interface
- 6) Operation Temperature : -20~70℃
- 7) Storage Temperature : -30~80℃
- 8) CTP cover lens : - /
- 9) CTP structure : - /
- 10) LED life time: -/

1.2 General specification

Item of	Contents	Unit
Panel Size	3.2	inch
LCD Type	a-si/TRANSMISSIVE	/
Display mode	Normally Black	/
Pixel arrangement	800*3(RGB)*216	Dots
Active Area	95.24 x 24.4	Mm
Module area (W*H*T)	100.4*32.9*.2.5	Mm
Recommended Viewing Direction	ALL	0' clock
LCM-IC	TBD	/
TP-IC	-	
Interface	RGB-24	/
Luminance for LCM	1000	cd/m2
Weight	TBD	g



2. DIAGRAM FOR LCM





3. I/O CONNECTION & BLOCK DIAGRAM

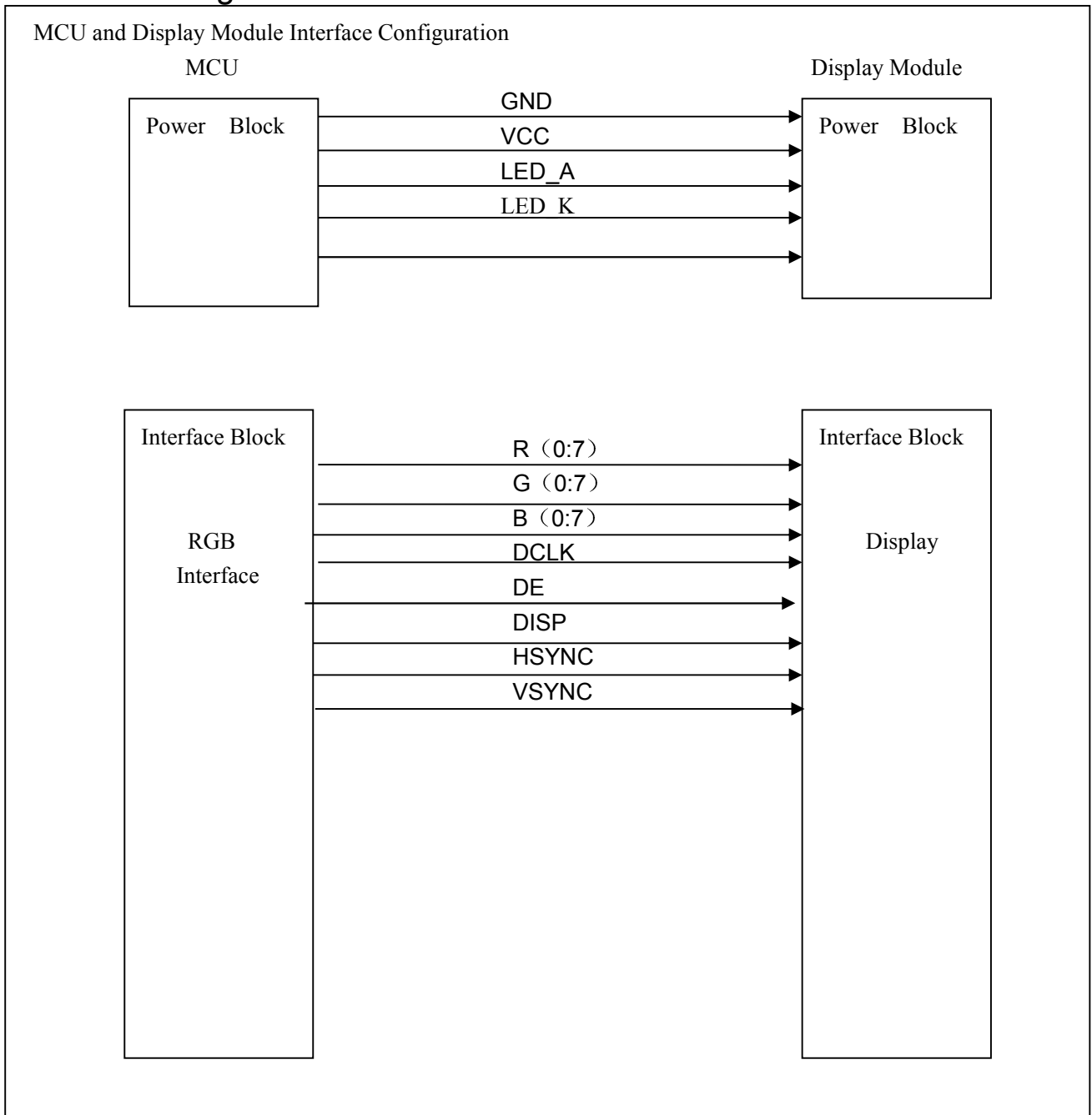
3.1 I/O connection

LCM Pin NO.	Symbol	I/O	Description
1	LED_K	P	Power supply for LED-
2	LED_A	P	Power supply for LED+
3	GND	P	Power Ground
4	NC	-	No connect
5	VCC		Power supply to the internal logic power regulator
6	NC	-	No connect
7-14	R0-R7	I	RED data
15-22	G0-G7	I	GREEN data
23-30	B0-B7	I	BLUE data
31	GND	P	Power Ground
32	DCLK	I	Parallel RGB clock input
33	DISP	I	Display control / standby mode selection
34	HSYNC	I	Horizontal sync signal; negative polarity.
35	VSYNC	I	Vertical sync signal; negative polarity.
36	DE	I	DATA INPUT Enable
37	NC	-	No connect
38-39	GND	P	Power Ground
40	NC	-	No connect

I: Input; O: Output; P: Power



3.2 block diagram





4. ELECTRICAL CHARACTERISTICS

4.1 Absolute Maximum Ratings

Item	Symbol	Rating	Unit
Power Supply Voltage	VDD	- 0.3 ~ +4.0	V
IO Supply Voltage	VDDI	- 0.3 ~ +4.0	V
Charge Pump Supply Voltage	PVDD	- 0.3 ~ +4.0	V
Enhance Charge Pump Supply Voltage	PVDD1	- 0.3 ~ +4.0	V
Logic Input Voltage Range	VIN	-0.3 ~ VDDI + 0.3	V
Logic Output Voltage Range	VOOUT	-0.3 ~ VDDI + 0.3	V
Operating Temperature Range	TOPR	-30 ~ +85	°C
Storage Temperature Range	TSTG	-40 ~ +125	°C

Note:

1. That the stress exceeds the Limiting Value listed above it may cause the driver IC permanent damage. These values are for stress only. IC should be operated under the DC/AC Characteristic conditions for normal operation. If these conditions are not met, IC operation may be error and the reliability may be deteriorated.
2. Parameters are valid over operating temperature range unless otherwise specified. All voltages are with respect to VSS unless otherwise noted.
3. Insure the voltage levels of VDDI, VDD, PVDD, PVDD1 always matches the correct relation:
 $3.1V \leq VDDI \leq VDD = PVDD = PVDD1 \leq 3.6V$
4. VIN should be less than or equal to 3.6V. ($VIN \leq 3.6V$)
5. Panel display quality depends on panel loading, and it may have the different performance at low/high temperature.
7. To avoid IC being affected by backlight temperature, it is recommended that the backlight led position shouldn't be near the periphery of IC.
8. IC can be operated normally at -30~85 degrees, but display quality at high/low temperatures may have different effect according to different panel characteristics.



4.2 Typical operation conditions

DC Electrical Characteristics (PVDD=PVDD1=VDD=VDDI= 3.3V, AGND= 0V, TA=25°C, Bare Chip)

Item	Symbol	Min.	Typ.	Max.	Unit	Conditions
Supply Voltage	VDD	3.1	3.3	3.6	V	
IO Supply Voltage	VDDI	3.1	3.3	3.6	V	
Charge Pump Supply Voltage	PVDD	3.1	3.3	3.6	V	
Enhance Charge Pump Supply Voltage	PVDD1	3.1	3.3	3.6	V	

4.3 Backlight Driving Conditions

Item	Symbol	Values			Unit	Remark
		Min	Typ	Max		
Voltage for LED Backlight	VL		15		V	Note2
Current for LED Backlight	IL		40		mA	
LED life time	-	30000	-	-	Hr	Note1

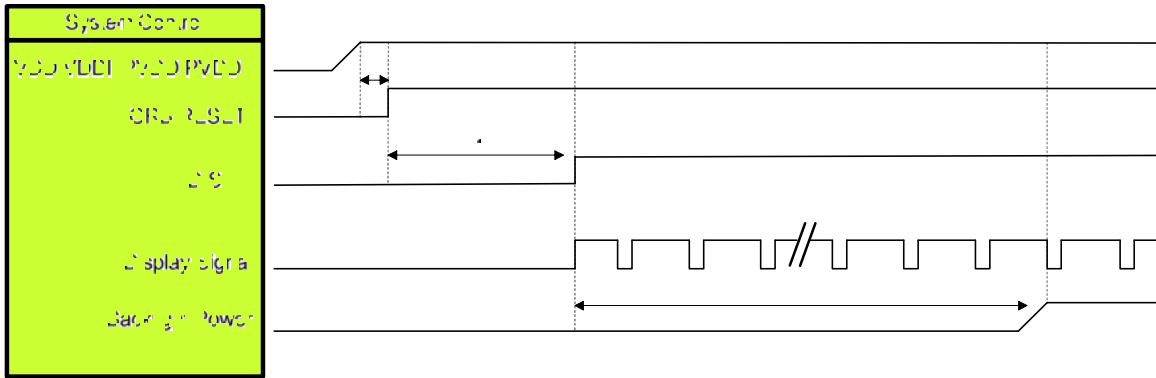
Note 1: The “LED life time” is defined as the module brightness decrease to 50% original brightness that the ambient temperature is 25 °C and IL=40mA. The LED lifetime could be decreased if operating IL is larger than 40 mA.

Note 2: The LED Supply Voltage is defined by the number of LED at Ta=25 °C and IL=40mA.



4.4 Power Sequence

4.4.1 Power On Sequence

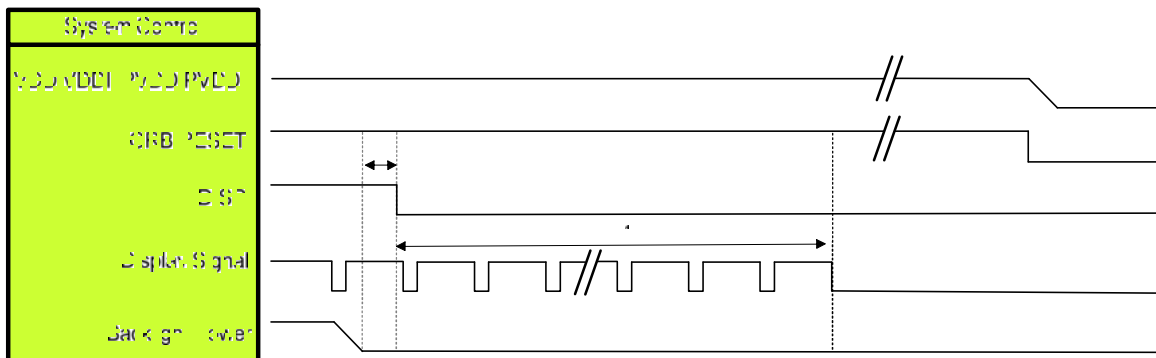


Symbol	Description	Min. Time	Unit
T0	System power stability to GRB RESET signal	0	ms
T1	GRB RESET= "High" to DISP="High"	10	ms
T2	Display Signal output to Backlight Power on	250	ms

Note :

1. When DISP pull "H" or "L", IC will execute the internal power on or power off procedures .Please be careful about the timing of DISP and do not interrupt it during power on or power off procedure, otherwise unexpected errors will occur.
2. RGB interface Display signal: DCLK; VSYNC; HSYNC; DE; DR[7:0]; DG[7:0]; DB[7:0]
3. LVDS interface Display signal: DCLK P/N; RX[3:0] P/N

4.4.2 Power Off Sequence



Symbol	Description	Min. Time	Unit
T0	Backlight Power off to DISP="Low"	5	ms
T1	DISP="Low" to IC internal voltage discharge complete	100	ms

Note :

1. When DISP pull "H" or "L", IC will execute the internal power on or power off procedures. Please be careful about the timing of DISP and do not interrupt it during power on or power off procedure, otherwise unexpected errors will occur.
2. RGB interface Display signal: DCLK; VSYNC; HSYNC; DE; DR[7:0]; DG[7:0]; DB[7:0]
3. LVDS interface Display signal: DCLK P/N; RX[3:0] P/N



4.5 Timing Characteristics

4.5.1 Timing Conditions

Parallel 24-bit RGB Input Timing (PVDD=PVDD1=VDD=VDDI= 3.3V, AGND= 0V, TA=25°C)

Parallel 24-bit RGB Interface Timing Table							
Item	Symbol	Min.	Typ.	Max.	Unit	Remark	
DCLK Frequency	Fclk	23	25	27	MHz		
HSYNC	Period Time	Th	808	816	896	DCLK	
	Display Period	Thdisp	800			DCLK	
	Back Porch	Thbp	4	8	48	DCLK	
	Front Porch	Thfp	4	8	48	DCLK	
	Pulse Width	Thw	2	4	8	DCLK	
VSYNC	Period Time	Tv	492	496	504	HSYNC	
	Display Period	Tvdisp	480			HSYNC	
	Back Porch	Tvbp	6	8	12	HSYNC	
	Front Porch	Tvfp	6	8	12	HSYNC	
	Pulse Width	Tvw	2	4	8	HSYNC	

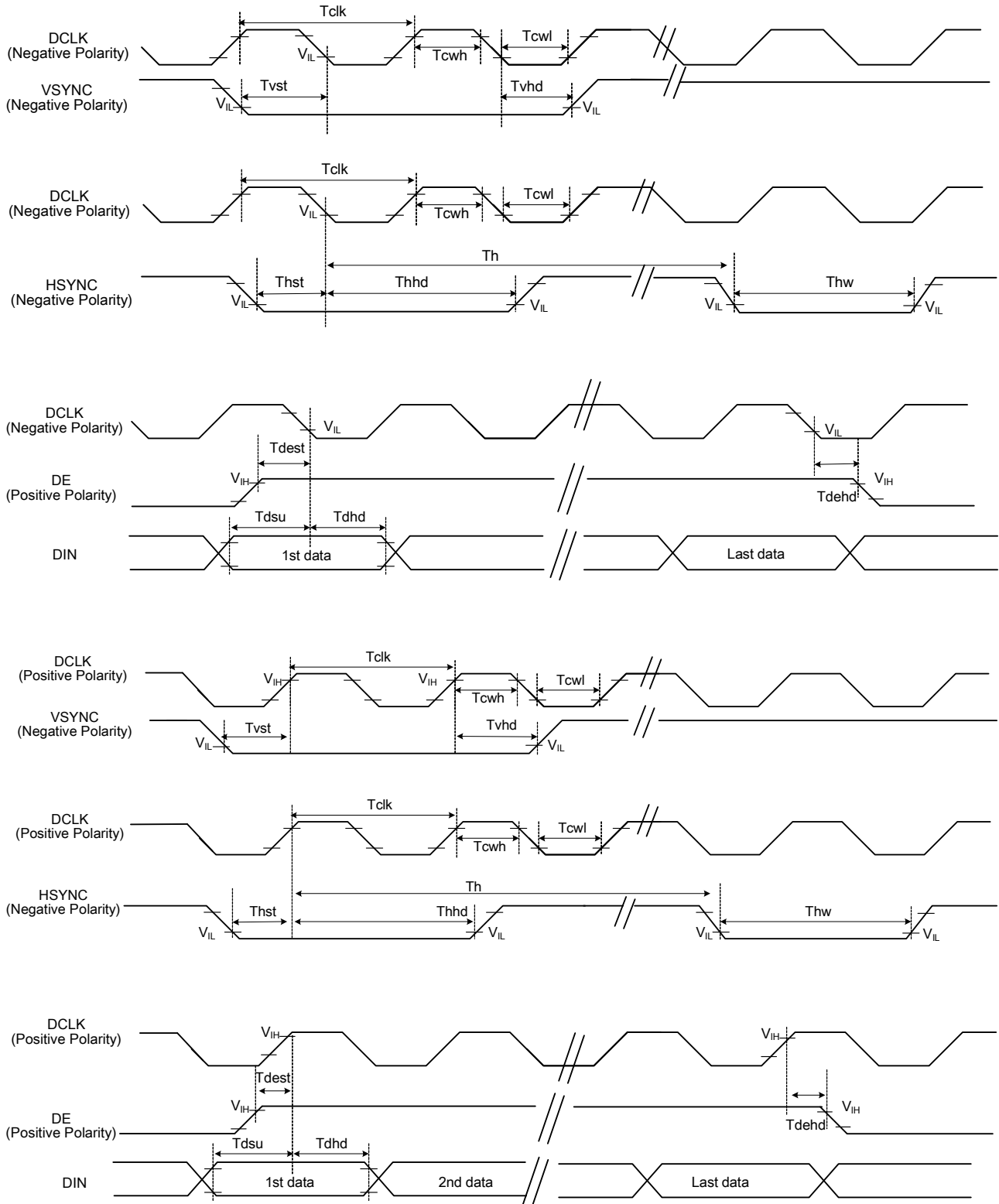
Note: 1. The minimum blanking time depends on the GIP timing of the panel specification

2. To ensure the compatibility of different panels, it is recommended to use the typical setting.

3. It is necessary to keep Tvbp =12 and Thbp =43 in sync mode. DE mode is unnecessary to keep it.



4.5.2 Timing Diagram





5. ELECTRO-OPTICAL CHARACTERISTICS

Parameter		Symbol	Condition	Min.	Typ.	Max.	Unit	Remark
Viewing Angle range	Horizontal	Θ_3	CR > 10	-	80	-	Deg.	Note 1
		Θ_9		-	80	-	Deg.	
	Vertical	Θ_{12}		-	80	-	Deg.	
		Θ_6		-	80	-	Deg.	
Luminance Contrast ratio		CR	$\Theta = 0^\circ$	-	1200	-		Note 2
Color Gamut	NTSC	CIE1931	$\Theta = 0^\circ$	-	50	-	%	Note 5 @C Light
Reproduction of color	White	Wx	$\Theta = 0^\circ$	Typ -0.03	0.311	Typ +0.03		
		Wy			0.338			
Response Time		Tr+Td	Ta= 25° C $\Theta = 0^\circ$	-	30	-	ms	Note 6

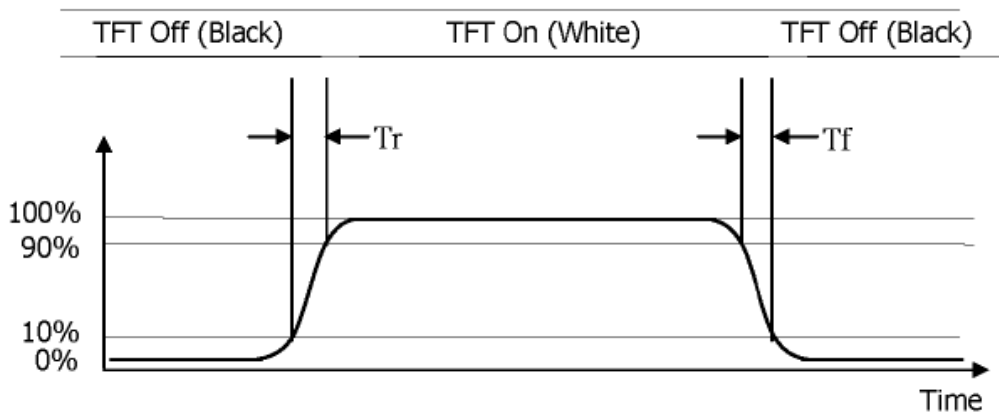


Note :

1. Viewing angle is the angle at which the contrast ratio is greater than 10. The viewing are determined for the horizontal or 3, 9 o'clock direction and the vertical or 6, 12 o'clock direction with respect to the optical axis which is normal to the LCD surface.
2. Contrast measurements shall be made at viewing angle of $\theta = 0^\circ$ and at the center of the LCD surface. Luminance shall be measured with all pixels in the view field set first to white, then to the dark (black) state. (See FIGURE 1 shown in Appendix)
Luminance Contrast Ratio (CR) is defined mathematically.

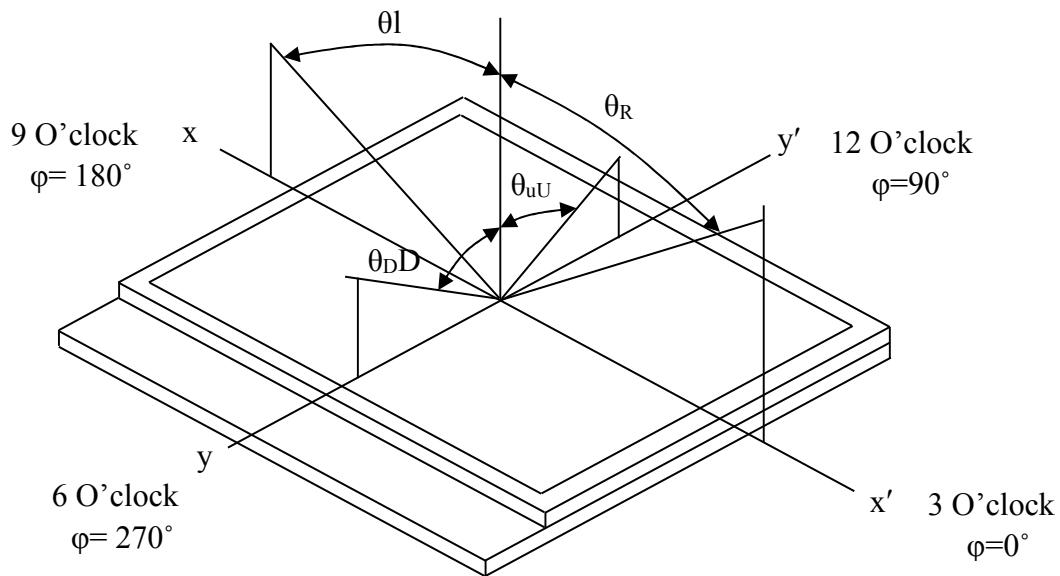
$$CR = \frac{\text{Luminance when displaying a white raster}}{\text{Luminance when displaying a black raster}}$$

3. Center Luminance of white is defined as the LCD surface. Luminance shall be measured with all pixels in the view field set first to white. This measurement shall be taken at the locations shown in FIGURE 4 for a total of the measurements per display.
4. The White luminance uniformity on LCD surface is then expressed as : $\Delta Y = \frac{\text{Minimum Luminance of 9 Points or 5 points}}{\text{Maximum Luminance of 9 Points or 5 points}}$ (See FIGURE 2).
5. The color chromaticity coordinates specified in Table 5. shall be calculated from the spectral data measured with C light. Measurements shall be made at the center of the panel.
6. The electro-optical response time measurements shall be made as FIGURE 5 shown in Appendix by switching the "data" input signal ON and OFF. The times needed for the luminance to change from 10% to 90% is T_d , and 90% to 10% is T_r .





Note4.Definition of Viewing Angle: The viewing angle range that the $CR \geq 10$



Note 5: Definition of Color Chromaticity (CIE 1931)

Color coordinate of white & red, green, blue at center point.



6. RELIABILITY TEST CONDITIONS

No	Test Item	Test Condition	STANDARD
1	High Temperature Storage	+80°C / 96Hours	1. Functional test is OK. Missing Segment, short, unclear segment, on-display, display abnormally and liquid crystal leak are un-allowed. 2. No low temperature bubbles, end seal loose and fall, frame rainbow.
2	Low Temperature Storage	-30°C / 96Hours	
3	High Temperature Operating	+70°C / 96Hours	
4	Low Temperature Operating	-20°C / 96Hours	
5	Thermal and cold shock	0°C↔+50°C x 10cycles (30min) (5min) (30min)	
6	Operate at High Temperature and Humidity	60°C x 90%RH / 24H	
7	Vibration Test	Frequency: 10Hz~55Hz~10Hz Amplitude:1.5mm, 2 hours for each direction of X, Y, Z	1. Function test is OK. 2. No glass crack, chipped glass, end seal loose and fall, epoxy frame crack and so on. 3. No structure loose and fall.
8	Dropping test	Drop to the ground from 1m height, 1 corner, 3 edges, 6 surfaces.	
9	ESD test	Contact: ±6KV Air: ±8KV 150PF/330Ω,5Points/panel,5times	The test results shall be subject to the whole machine test.

NOTE:

1. The reliability items will be fully performed in new sample qualification,
2. The reliability status will be tested as monitor during mass production. Individual reliability test shall be performed by lot, Moreover, the individual reliability item shall be decided according to reliability plan.
3. All samples are inspected after keeping in the room with normal temperature and humidity for 2 hours or above.
4. Vibration test: It is not necessary to test for those products without assembly frame, backlight, PCB and so on.
5. Dropping test: It is necessary for affirming new package.
6. For the high temperature and high humidity test, pure water of over 10 MΩ.cm should be used.
7. Each test item applies for test LCM only once. Then tested LCM cannot be used again in any other test item.
8. The quantity of LCM examination for each test item is 5pcs to 10pcs.



7. INSPECTION STANDARDS

8.1 AQL Sampling inspection standard

使用 GB/T 2828-2003 一般 II 水平, 采用正常检查一次抽样方式; 具体抽检方式参照《成品检验管理程序》、《抽样管理规范》

缺陷区分	AQL 允收水准
严重缺陷	0 收 1 退
重缺	0.4
轻缺	1.0

8.2 Inspect the condition

8.2.1 在 20—40W 日光灯的照明条件下, 样品离检查者眼睛约 30cm 处进行检查。检验方向以垂直线前后左右 45° (以时钟 3 点、6 点、9 点、12 点)

8.2.2 检验者视力需达到标准视力 1.0 以上。

8.2.3 检验者需戴静电手环、两手八个手指套。

8.2.4 外观检验者以目视检查或以菲林对比卡比对。

8.2.5 电性测试使用电测测架, 主板, 电源线及单片机。

8.2.6 若标准与规格书不符时, 以产品发行之规格书特殊检验规格、工程变更为准

8.2.7 辉色度检测请参照样品, 检测方法依照辉色度检验标准。

8.2.8 电测检验环境: 照度为 200LUX 以下, 外观检验环境: 照度为 600LUX-1000LUX, 检验时间: 1 秒-3 秒。

8.2.9 检验工具: 电测测架, 主板, 电源线及单片机, 菲林对比卡, 游标卡尺, 放大镜, 实体显微镜 (必要时) 等等。

8.3 Judgment criterion

小尺寸点、线判定标准: (6.2 寸以内)

1	点状缺陷 (磨伤、异物、针孔、凹痕、缺膜、气泡、白点、彩点、脏点)		判定 (A/B/C 区)	$D \leq 0.10$, 忽略不计, 但密集型不允许	MI	OK
				$0.1 < D \leq 0.15$, $ds \geq 10$		$N \leq 2$
				$0.15 < D \leq 0.2$, $ds \geq 10$		$N \leq 1$
				LCD 亮点: $0.15 < D$		$N \leq 1$
				$D > 0.2$		NG
			判定 (D 区)	同背面丝印油墨区杂质判定标准		
			注: 1) D 区的点状缺陷需在不影响 CTP 功能、客户组装及整机的外观的情况下, 判定 OK		MI	
2	线状缺陷 (磨伤、无感划伤、毛屑、纤维等)		判定 (A/B/C 区)	$W \leq 0.03mm$, $L \leq 3mm$, $ds \geq 10$	MI	$N \leq 2$
				$0.03mm < W \leq 0.05mm$, $L \leq 3mm$, $ds \geq 10$		$N \leq 1$
				$W > 0.05mm$ 或 $L > 3mm$		NG



中尺寸点、线判定标准：（6.2~8寸以内）

1	点状缺陷 (磨伤、异物、针孔、凹痕、缺膜、气泡、白点、彩点、脏点)		判定(A/B/C区)	$D \leq 0.10$, 忽略不计, 但密集型不允许	MI	OK
				$0.15 < D \leq 0.25, ds \geq 10$ $0.25 < D \leq 3, ds \geq 10$ LCD亮点: $0.2 < D$ $D > 0.3$		N ≤ 2
			判定(D区)	同背面丝印油墨区杂质判定标准		N ≤ 1
			注: 1) D区的点状缺陷需在不影响CTP功能、客户组装及整机的外观的情况下, 判定OK		MI	N ≤ 1
						NG
2	线状缺陷 (磨伤、无感划伤、毛屑、纤维等)		判定(A/B/C区)	$W \leq 0.03mm, L \leq 3mm, ds \geq 10$	MI	N ≤ 2
				$0.03mm < W \leq 0.05mm, L \leq 3mm, ds \geq 10$		N ≤ 1
				$W > 0.05mm$ 或 $L > 3mm$		NG

大尺寸点、线判定标准：（8.1~13.3寸以内）

1	点状缺陷 (磨伤、异物、针孔、凹痕、缺膜、气泡、白点、彩点、脏点)		判定(A/B/C区)	$D \leq 0.1$, 忽略不计, 但密集型不允许	MI	OK
				$0.15 < D \leq 0.3, ds \geq 10$ $0.3 < D \leq 0.35, ds \geq 10$ LCD亮点: $0.25 < D$ $D > 0.35$		N ≤ 2
			判定(D区)	同背面丝印油墨区杂质判定标准		N ≤ 1
			注: 1) D区的点状缺陷需在不影响CTP功能、客户组装及整机的外观的情况下, 判定OK		MI	N ≤ 1
						NG
2	线状缺陷 (磨伤、无感划伤、毛屑、纤维等)		判定(A/B/C区)	$W \leq 0.05mm, L \leq 5mm, ds \geq 10$	MI	N ≤ 2
				$0.05mm < W \leq 0.07mm, L \leq 5mm, ds \geq 10$		N ≤ 1
				$W > 0.07mm$ 或 $L > 5mm$		NG



8. PACKAGE DRAWING

